

FACSIMILE COVER SHEET

CONFIDENTIAL AND PRIVILEGED

**Perkins
Coie**

1201 Third Avenue, Suite 4800
Seattle, WA 98101-3099
PHONE: 206.583.8888
FAX: 206.583.8500
www.perkinscoie.com

DATE: February 4, 2004 COVER SHEET & 2 PAGE(S)

ATTORNEY DOCKET NUMBER: 108298727US

RETURN TO: (NAME) Stephen P. Whelan (EXT.) 3209 (ROOM NO.) 4195

ORIGINAL DOCUMENT(S) WILL BE: ☐ SENT TO YOU ☒ HELD IN OUR FILES

SENDER:	TELEPHONE:	FACSIMILE:
Stephen P. Whelan	(206) 359-3209	(206) 359-4209

	TELEPHONE:	FACSIMILE:
Office of Initial Patent Examination Filing Receipt Corrections	United States Patent and Trademark Office	(703) 746-9195

IN RE APPLICATION OF: DAVID A. PALSULICH ET AL
APPLICATION NO.: 10/636,021
FILED: AUGUST 6, 2003
FOR: MICROFEATURE WORKPIECE PROCESSING SYSTEM FOR, E.G., SEMICONDUCTOR WAFER ANALYSIS
ART UNIT: 2812
CONF. NO: 1017

Enclosures: Request for Corrected Filing Receipt (1 page)
Copy of Official Filing Receipt with Handwritten Correction (1 page)

I hereby certify that this correspondence is being transmitted via facsimile to the United States Patent and Trademark Office at (703) 746-9195, on:

Date: February 4, 2004

By: Stephen P. Whelan
Stephen P. Whelan


This Fax contains confidential, privileged information intended only for the intended addressee. Do not read, copy or disseminate it unless you are the intended addressee. If you have received this Fax in error, please email it back to the sender at perkinscoie.com and delete it from your system or call us (collect) immediately at 206.583.8575, and mail the original Fax to Perkins Coie LLP, 1201 Third Avenue, Suite 4800, Seattle, WA 98101-3099.

ANCHORAGE • BEIJING • BELLEVUE • BOISE • CHICAGO • DENVER • HONG KONG • LOS ANGELES
MENLO PARK • OLYMPIA • PORTLAND • SAN FRANCISCO • SEATTLE • SPOKANE • WASHINGTON, D.C.

Perkins Coie LLP

Attorney Docket No. 108298727US
Disclosure No. 00-1010

I hereby certify that this correspondence is being transmitted via facsimile to the United States Patent and Trademark Office at (703) 746-9195, on:

Date: February 4, 2004By: 
Stephen P. Whelan

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF: DAVID A. PALSULICH AND
RONALD F. BALDNER
APPLICATION NO.: 10/636,021
FILED: AUGUST 6, 2003
FOR: MICROFEATURE WORKPIECE
PROCESSING SYSTEM FOR, E.G.,
SEMICONDUCTOR WAFER ANALYSIS

EXAMINER: (TO BE ASSIGNED)
ART UNIT: 2812
CONF. NO: 1017

Request For Corrected Filing Receipt

Sir/Madam:

Attached is a copy of the official Filing Receipt received from the U.S. Patent and Trademark Office in the above-identified application, for which issuance of a corrected Filing Receipt is respectfully requested. There is an error with respect to the Title, which was incorrectly entered. The corrections to be made have been marked on the enclosed copy of the Filing Receipt. The corrections are not due to any errors by applicants, and therefore no fee is due.

Respectfully submitted,
Perkins Coie LLPDate: 4 Feb 04
Edward S. Hotchkiss
Registration No. 33,904Correspondence Address:

Customer No. 25096
Perkins Coie LLP
P.O. Box 1247
Seattle, Washington 98111-1247
(206) 359-8000



DE-DOCKETED

UNITED STATES PATENT AND TRADEMARK OFFICE

UNITED STATES DEPARTMENT OF COMMERCE
United States Patent and Trademark Office
Address COMMISSIONER FOR PATENTS
P.O. Box 1450
Alexandria, Virginia 22313-1450
www.uspto.gov

10829.8727 US
ESH/SW

APPL NO.	FILING OR 371 (c) DATE	ART UNIT	FIL FEE REC'D	ATTY. DOCKET NO	DRAWINGS	TOT CLMS	IND CLMS
10/636,021	08/06/2003	2812	1422	108298727US	5	48	5

RECEIVED

CONFIRMATION NO. 1017

25096
PERKINS COIE LLP
PATENT-SEA
P.O. BOX 1247
SEATTLE, WA 98111-1247

NOV 10 2003

PERKINS COIE LLP

FILING RECEIPT



OC000000011194975

Date Mailed: 11/06/2003

Receipt is acknowledged of this regular Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please write to the Office of Initial Patent Examination's Filing Receipt Corrections, facsimile number 703-746-9195. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

Applicant(s)

David A. Palsulich, Boise, ID;
Ronald F. Baldner, Boise, ID;

Domestic Priority data as claimed by applicant**Foreign Applications****If Required, Foreign Filing License Granted: 11/05/2003****Projected Publication Date: 02/10/2005****Non-Publication Request: No****Early Publication Request: No****Title**

Microfeature workpiece processing system for, e.g., semiconductor wafer analysis

Preliminary Class